



Silicon Storage Technology, Inc.

May 13, 2008

Certification of Non-use of Hazardous Substances

Silicon Storage Technology, Inc. (SST) hereby certifies that all parts currently manufactured by or on behalf of SST are fully compliant with RoHS, as well as other internationally recognized and widely accepted corporate and governmental environmental standards. In addition, SST certifies that all package and/or packing material used for delivery of SST parts meet the same requirements.

The following table is an abbreviated list of the most common banned substances and their limits.

<u>Substance</u>	<u>Limit</u>
Lead and it's compounds	100ppm plastics
Mercury and it's compounds	50 PPM
Cadmium or cadmium compounds	5 PPM plastics
Hexavalent Chromium and it's compounds	500 ppm
Poly Brominated Biphenyls (PBB)	1000 ppm
Poly Brominated Diphenyl Ethers (PBDE)	1000 ppm *
Other Bromines (including TBBPA)	900 ppm
Chlorines (Including SCCP, PCB, PCN etc.)	900 ppm
Antimony Trioxide	1000 ppm
Red Phosphorous	1000 ppm
PFOS/PFOA	1000ppm **
Arsenic and its compounds	50 ppm ***
Formaldehydes	.1 ml/ m ³
Polyvinyl chloride (PVC)	No intentional use
Organic Tin compounds	No intentional use
Asbestos and its compounds	No intentional use
Dioxins and other carcinogenic substances	No intentional use
Azo compounds/ Aromatic Amines	No Intentional use
Radioactive Substances	No intentional use
Ozone depleting substances	No intentional use

* Includes Deca-BDE

** Exempt from RoHS limit requirements when used in photo lithography

*** Exempt from RoHS limit requirements when used in semiconductor manufacturing (e.g. dopants, substrates etc.)

Sincerely,

Terry Scott
Vice President, Quality

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